

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of : Confirmation No. 6849

Takeshi HASHIMOTO et al. : Docket No. 2001_1790

Serial No. 10/029,991 : Group Art Unit 1712

Filed December 31, 2001 : Examiner M. Zimmer

THERMOSETTING LOW-DIELECTRIC RESIN COMPOSITION AND USE THEREOF

RESPONSE

THE COMMISSIONER IS AUTHORIZED TO CHARGE ANY DEFICIENCY IN THE FEES FOR THIS PAPER TO DEPOSIT ACCOUNT NO. 23-0975

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the Official Action dated April 10, 2003, the period for response having been extended for one month by the attached Petition, please amend the present application as follows:

RECEIVED
AUG 13 2003
TC 1700